

N0439N

N-channel MOSFET 40 V, 90 A, 3.3 m Ω

R07DS1065EJ0100 Rev.1.00 Jun 13, 2013

Description

This product is N-channel MOS Field Effect Transistors designed for high current switching applications.

Features

• Super low on-state resistance

 $R_{DS(on)}$ = 3.3 m Ω MAX. (V_{GS} = 10 V, I_D = 45 A)

• Low Ciss : Ciss = 3900 pF TYP. (V_{DS} = 25 V)



TO-220

Ordering Information

Part No.	LEAD PLATING	PACKING	Package	
N0439N-S19-AY*1	Pure Sn (Tin)	Tube 50 p/tube	TO-220 1.9g TYP.	

Note: *1. Pb-free (This product does not contain Pb in the external electrode.)

Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	40	V
Gate to Source Voltage (V _{DS} = 0 V)	V_{GSS}	± 20	V
Drain Current (DC) (T _C = 25 °C)	I _{D(DC)}	± 90	Α
Drain Current (pulse) *1	I _{D(pulse)}	± 360	Α
Total Power Dissipation (T _C = 25 °C)	P _{T1}	147	W
Total Power Dissipation (T _A = 25 °C)	P _{T2}	1.8	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	-55 to 175	°C
Repetitive Avalanche Current *2	I _{AR}	37	Α
Repetitive Avalanche Energy *2	E _{AR}	136	mJ

Notes: *1. T_C=25°C 、 Pw \leq 10 μ s, Duty Cycle \leq 1%

Thermal Resistance

Channel to Case Thermal Resistance	$R_{th(ch-C)}$	1.02	°C/W
Channel to Ambient Thermal Resistance	$R_{th(ch-A)}$	83.3	°C/W

^{*2.} $R_G = 25\Omega$, $V_{GS} = 20 \rightarrow 0V$

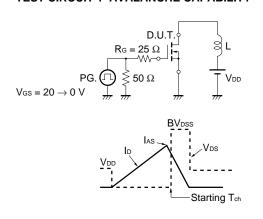
Electrical Characteristics (T_A = 25°C)

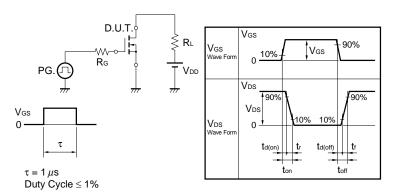
Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	V _{DS} = 40V, V _{GS} = 0 V
Gate Leakage Current	I _{GSS}			±100	nA	V_{GS} = \pm 20 V, V_{DS} = 0 V
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	V _{DS} = V _{GS} , I _D = 250 μA
Forward Transfer Admittance *1	y _{fs}	30			S	V _{DS} = 5 V, I _D = 45 A
Drain to Source On-state Resistance *1	R _{DS(on)}		2.75	3.30	mΩ	V _{GS} = 10 V, I _D = 45 A
Input Capacitance	C _{iss}		3900	5850	pF	V _{DS} = 25 V
Output Capacitance	C _{oss}		530	800	pF	V _{GS} = 0 V
Reverse Transfer Capacitance	C _{rss}		200	360	pF	f = 1 MHz
Turn-on Delay Time	t _{d(on)}		25	60	ns	V _{DD} = 20V, I _D = 45 A
Rise Time	t _r		12	30	ns	V _{GS} = 10 V
Turn-off Delay Time	$t_{d(off)}$		65	130	ns	$R_G = 0 \Omega$
Fall Time	t _f		8	20	ns	
Total Gate Charge	Q_{G}		68	102	nC	V _{DD} = 32V
Gate to Source Charge	Q_{GS}		18		nC	V _{GS} = 10 V
Gate to Drain Charge	Q_{GD}		18		nC	I _D = 90 A
Body Diode Forward Voltage *1	$V_{F(S-D)}$		0.95	1.5	V	I _F = 90 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}		47		ns	I _F = 90 A, V _{GS} = 0 V
Reverse Recovery Charge	Q _{rr}		68		nC	di/dt = 100 A/μs

Note: *1. Pulsed test

TEST CIRCUIT 1 AVALANCHE CAPABILITY

TEST CIRCUIT 2 SWITCHING TIME



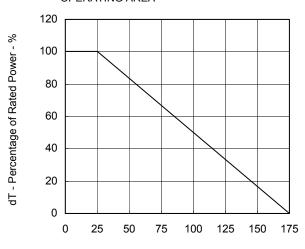


TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c} D.U.T. \\ \hline I_G = 2 \begin{array}{c} mA \\ \hline W \\ \hline \end{array} \\ \hline PG. \\ \hline \end{array} \begin{array}{c} SRL \\ \hline \end{array}$$

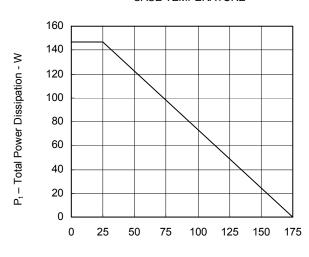
TYPICAL CHARACTERISTICS (T_A = 25°C)

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



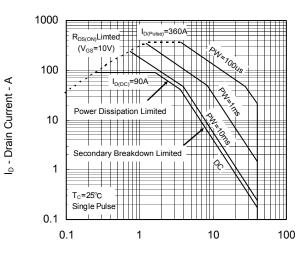
T_C - Case Temperature - °C

TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



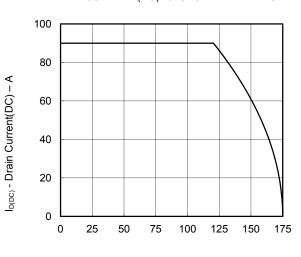
T_C - Case Temperature - °C

FORWARD BIAS SAFE OPERATING AREA



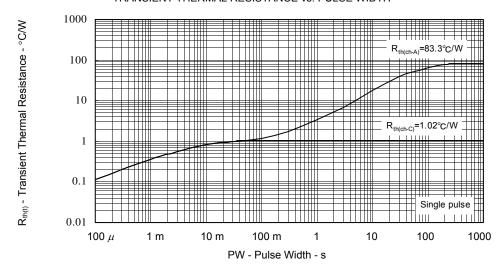
 V_{DS} - Drain to Source Voltage – V

DRAIN CURRENT(DC) vs. CASE TEMPERATURE

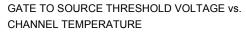


 T_{C} - Case Temperature - $^{\circ}\text{C}$

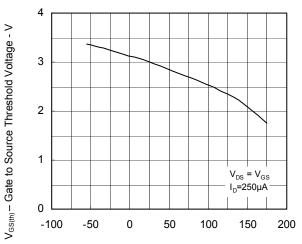
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE 400 350 300 I_D - Drain Current - A 250 200 150 100 V_{GS}=10V 50 Pulsed 0 0 0.2 0.4 0.6 8.0 1.2 1

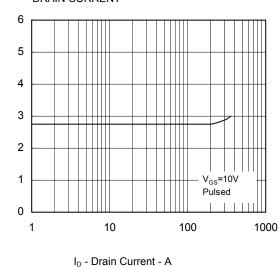


 $V_{\text{\scriptsize DS}}$ - Drain to Source Voltage - V

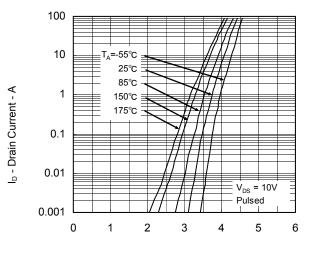


T_{ch} - Channel Temperature - °C

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

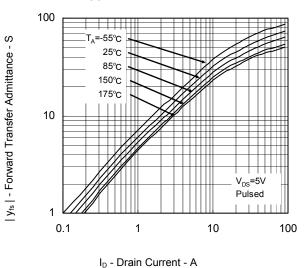


FORWARD TRANSFER CHARACTERISTICS

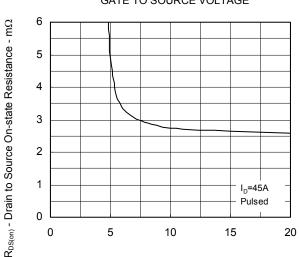


V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



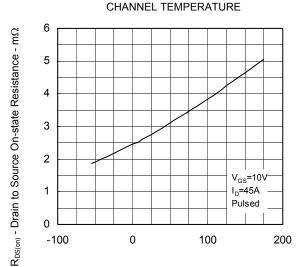
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



V_{GS} - Gate to Source Voltage - V

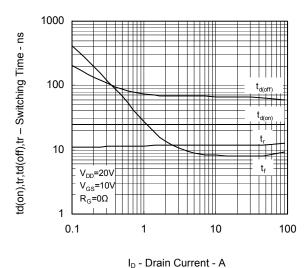
 $R_{\text{DS}(\text{on})}$ - Drain to Source On-state Resistance - $m\Omega$

DRAIN TO SOURCE ON-STATE RESISTANCE vs.

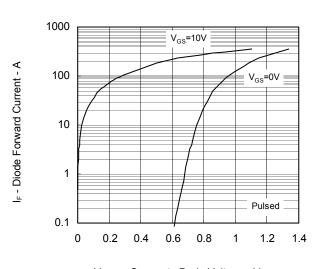


T_{ch} - Channel Temperature - °C

SWITCHING CHARACTERISTICS

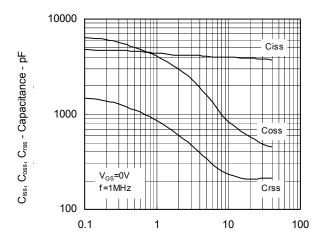


SOURCE TO DRAIN DIODE FORWARD VOLTAGE



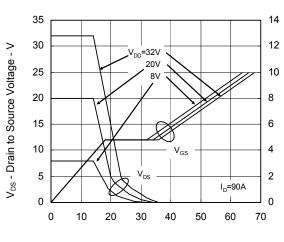
 $V_{\text{F(S-D)}}$ - Source to Drain Voltage - V

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



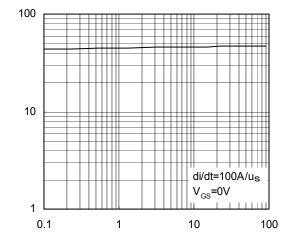
V_{DS} - Drain to Source Voltage - V

DYNAMIC INPUT/OUTPUT CHARACTERISTICS



Q_G - Gate Charge - nC

REVERSE RECOVERY TIME vs. DRAIN CURRENT



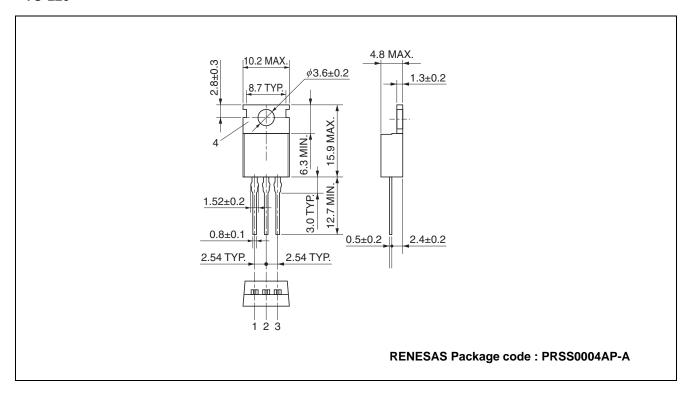
I_F - Drain Current - A

t_{rr} - Reverse Recovery Time - ns

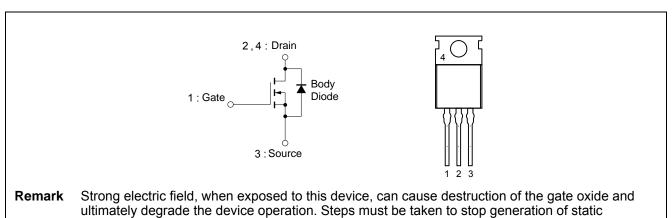
V_{GS} - Gate to Source Voltage - V

Package Drawings (Unit: mm)

TO-220



Equivalent Circuit / Pin Assignment



electricity as much as possible, and quickly dissipate it once, when it has occurred.

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